



MIRAI 2.0 Research and Innovation Week JUNE 7-11, 2021

International Collaboration in a Digital Era - Fostering Innovative Minds for the Future



Welcome to register and join the event!

Register to R&I Week Deadline June 6

The overall program with links to tentative programs for all scientific sessions is here.

Our faculty members and researchers will present their research at this event!

Research and Innovation week, June 7-11, 2021

This digital event, hosted by the University of Gothenburg, is open to all member universities of MIRAI 2.0.

This digital event will gather researchers from all member universities in Sweden and Japan as well as university leadership representatives, industry and research funding agencies. Connect with researchers within your field join scientific sessions within MIRAI 2.0 themes: **Ageing, Artificial Intelligence, Innovation and Entrepreneurship, Materials Science** and **Sustainability**.

This event focuses on connecting researchers with similar interests as well as discussing and sharing collaboration ideas. Researchers from MIRAI2.0 universities can join our digital poster session and present their own research. **A matchmaking event** with researchers, companies and organizations will be arranged to support cross sector exchange of expertise and ideas.

About MIRAI 2.0

Connecting Swedish and Japanese universities through research, education and innovation is a three-year project (2020 – 2022) addressing scientific issues within Ageing, Materials Science, Sustainability and Innovation and Entrepreneurship relevant to both countries.

Swedish Universities

University of Gothenburg (coordinating University)
Linköping University, Lund University, Uppsala University, Umeå University, Linnaeus University, Karlstad University, Örebro University, Jönköping University, Luleå University of Technology, Stockholm School of Economics (Associate member)

Japanese Universities

Nagoya University (coordinating University)
Hiroshima University, Hokkaido University, **Sophia University**, Kyushu University, The University of Tokyo, Tohoku University, Waseda University

